

Auto Focus (AF) Controller & Driver

LC898217XC

Overview

LC898217XC is an AF control LSI. It consists of 1 system of feedback circuit for AF control.

Features

- Built-in Equalizer Circuit Using Digital Operation
 - AF Control Equalizer Circuit
 - Any Coefficient can be Specified by 2-wire Serial I/F (TWIF)
- 2-wire Serial Interface

(The Communication Protocol is Compatible with I²C)

- Built-in A/D Converter
 - ◆ Input 1 Channel
- Built-in D/A Converter
 - Output 2 Channel (Hall Offset, Constant Current Bias)
- Built-in VGA
 - Hall Amp
 - 1 Channel
- Built-in EEPROM
 - 128 Byte (16 Byte/Page)
- Built-in OSC
- Built-in Constant Current Driver
 - ♦ 110 mA
 - 1 Channel
- Package
 - ♦ WLCSP 10-pin
- Supply Voltage
 - V_{DD} (2.6 V to 3.3 V)
- This Device is Pb-Free, Halogen Free/BFR Free and is RoHS Compliant



WLCSP10, 1.04x2.04 CASE 567LF

MARKING DIAGRAM

8217XC ALYWW

8217XC = Specific Device Code

= Assembly Location

= Wafer Lot Y = Year

WW = Work Week

ORDERING INFORMATION

| Device O | Package | Shipping [†] |
|---------------|---------|-----------------------|
| LC898217XC-MH | WLCSP10 | 4000 / |
| 12 SN | | Tape & Reel |

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

PIN DESCRIPTION

Table 1. PIN DESCRIPTION

| Pin Name | Description |
|----------|-------------------|
| I | Input |
| Р | Power Supply, GND |
| NC | Not Connect |
| 0 | Output |
| В | Bidirection |

• 2-wire serial interface

SCL 2-wire serial interface clock pin **SDA** В 2-wire serial interface data pin

Hall interface

BIASO O D/A output (to Hall element) OPINP I VGA input (from Hall element) OPINM I VGA input (from Hall element)

• Driver interface

OUT1 O Driver output (to Actuator) OUT2 O Driver output (to Actuator)

• Power supply pin

 V_{DD} Power Supply

 V_{SS}

• Test pin

or output WE PLEASENTAL PREPARED TO THE PLEASENTAL PREPARED TO THE PREPARED TO PORT B

*Process when pins are not used

PIN TYPE "O" – Ensure that it is set to OPEN.

PIN TYPE "I" - OPEN is inhibited. Ensure that it is connected to the V_{DD} or V_{SS} even when it is unused. (Please contact \mbox{onsemi} for more information about

selection of V_{DD} or V_{SS}.)

PIN TYPE "B" - If you are unsure about processing method on the pin description of pin layout table, please contact us.

Note that incorrect processing of unused pins may result in defects.

*In case of connecting PORT pin with HOST CPU

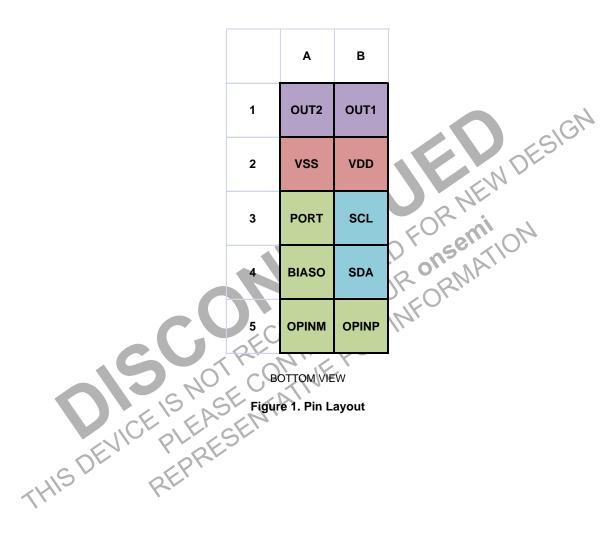
When LC898217XC is power off and HOST CPU is power on, a HOST CPU pin connected with PORT pin have to be

PIN LAYOUT

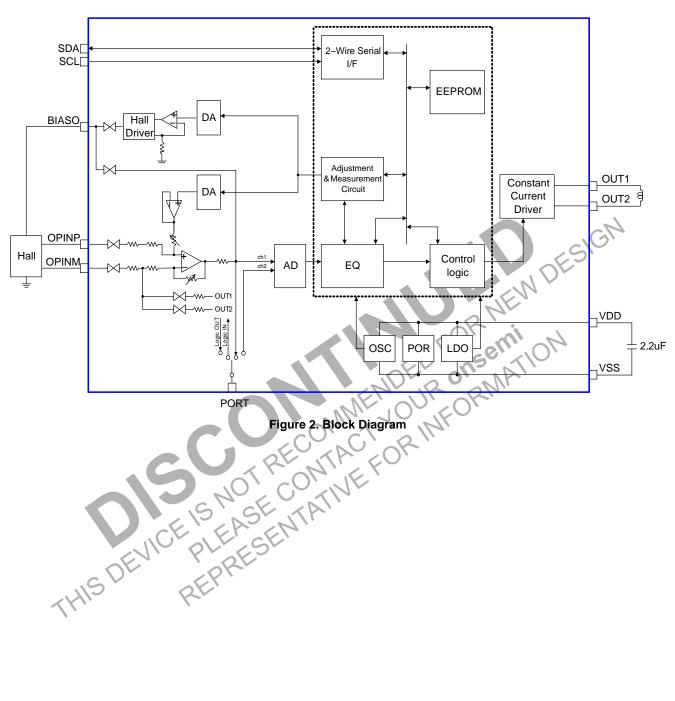
Table 2. PIN LAYOUT

| | Circuit Name | Number of PINs | Circuit Name | Number of PINs |
|---|--------------|----------------|--------------|----------------|
| I | Analog | 4 | Driver | 2 |
| I | Logic | 2 | Power | 2 |

[&]quot;PORT" pin has analog function and digital function.



BLOCK DIAGRAM



ELECTRICAL CHARACTERISTICS

Table 3. ABSOLUTE MAXIMUM RATINGS ($V_{SS} = 0 V$)

| Symbol | Item | Condition | Rating | Unit |
|--------------------------------------|-------------------------------|-----------|----------------------------------|------|
| V _{DD} 33 max | Supply voltage | Ta ≤ 25°C | -0.3 to 4.6 | V |
| V _I 33, V _O 33 | Input/output voltage | Ta ≤ 25°C | -0.3 to V _{DD} 33 + 0.3 | V |
| Tstg | Storage ambient temperature | | -55 to 125 | °C |
| Topr | Operating ambient temperature | | -30 to 70 | °C |

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

Table 4. ALLOWABLE OPERATING RATINGS (Ta = -30 to 70° C, VSS = 0 V, 3 V power supply (V_{DD}))

| Symbol | Item | Min | Тур | Max | Unit |
|--------------------|---------------------|-----|-----|--------------------|------|
| V _{DD} 33 | Supply voltage | 2.6 | 2.8 | 3.3 | V |
| V _{IN} | Input voltage range | 0 | | V _{DD} 33 | V |

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

Table 5. DC CHARACTERISTICS (Input / output level at $V_{SS} = 0 \text{ V}$, $V_{DD} = 2.6 \text{ to } 3.6 \text{ V}$, $Ta = -30 \text{ to } 70^{\circ}\text{C}$)

| Symbol | Item | Condition | Min | Тур | Max | Unit | Applicable Pins |
|-----------------|---------------------------|------------------------|----------------------|-----|-------|------|-------------------|
| V _{IH} | High-level input voltage | CMOS compliant Schmitt | 1.4 | | 50, < | 7 | SCL, SDA, PORT |
| V _{IL} | Low-level input voltage | | 10/2 | 0,0 | 0.4 | V | PORT |
| V _{OH} | High-level output voltage | IOH = -2 mA | V _{DD} -0.4 | | 5/4. | V | PORT |
| V _{OL} | Low-level output voltage | IOL = 2 mA | 40, | IFO | 0.4 | V | SDA, PORT |
| Rdn | Pulldown resistor | (0) | 50 | | 220 | kΩ | PORT |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

Table 6. DRIVER OUTPUT (OUT1, OUT2) ($V_{SS} = 0 \text{ V}, V_{DD} = 2.8 \text{ V}, \text{ Ta} = 25^{\circ}\text{C}$)

| Symbol | Item Condition | Min | Тур | Max | Unit | Applicable Pins |
|--------|---------------------|-----|-----|-----|------|-----------------|
| Ifull | Maximum current | 105 | | 115 | mA | OUT1, OUT2 |
| loleak | Output leak current | | 1 | | μΑ | |

Table 7. NON-VOLATILE MEMORY CHARACTERISTICS

| Symbol | ltem | Condition | Min | Тур | Max | Unit | Applicable Circuit |
|--------|----------------|-----------|-----|-----|------|--------|--------------------|
| EN | Endurance | | | | 1000 | Cycles | EEPROM |
| RT | Data retention | | 10 | | | Years | |
| tWT | Write time | | | | 20 | ms | |

AC CHARACTERISTICS

V_{DD} Supply Timing

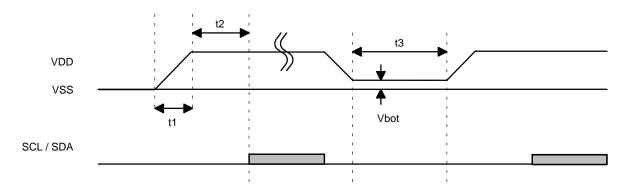


Figure 3. V_{DD} Supply Timing

It is available to use 2-wire serial interface 5 ms later for Power On Reset of V_{DD}.

Table 8. VDD SUPPLY TIMING

| Symbol | Item | Min Typ | Max | Unit |
|--------|--|---------|-----|------|
| t1 | V _{DD} turn on time | OK 31 - | 3 | ms |
| t2 | 2-wire serial interface start time from V _{DD} on | 5 | | ms |
| t3 | V _{DD} off time | 100 | | ms |
| Vbot | Bottom Voltage | -BN | 0.1 | V |

AC Specification

Figure 4 shows interface timing definition and Table 9 shows electric characteristics.

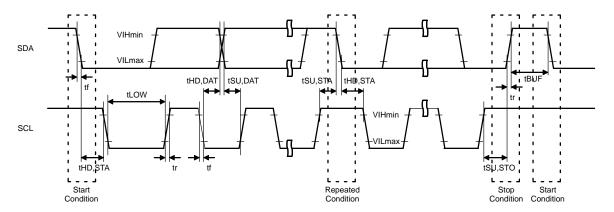


Figure 4. 2-wire Serial Interface Timing Definition

Table 9. ELECTRICAL CHARACTERISTICS FOR 2-WIRE SERIAL INTERFACE (AC CHARACTERISTICS)

| | | Pin | I | Fast-mode | , | Fas | st-mode P | lus | |
|---------|---|------------|---------------|-----------|--------------|---------------|-----------|------|------|
| Symbol | ltem | Name | Min | Тур | Max | Min | Тур | Max | Unit |
| FSCL | SCL clock frequency | SCL | | | 400 | olu, | M | 1000 | kHz |
| tHD,STA | START condition hold time | SCL SDA | 0.6 | OE | 000 | 0.26 | 10. | | μS |
| tLOW | SCL clock Low period | SCL | 1.3 | 1 | | 0.5 | | | μS |
| tHIGH | SCL clock High period | SCL | 0.6 | 10 | NFO | 0.26 | | | μS |
| tSU,STA | Setup time for repetition START condition | SCL SDA | 0.6 | OR | | 0.26 | | | μS |
| tHD,DAT | Data hold time | SCL SDA | 0 (Note 1) | 7 | 0.9 | 0 (Note 1) | | | μS |
| tSU,DAT | Data setup time | SCL SDA | 100 | | | 50 | | | ns |
| tr | SDA, SCL rising time | SCL SDA | | | 300 | | | 120 | ns |
| tf | SDA, SCL falling time | SCL SDA | | | 300 | | | 120 | ns |
| tSU,STO | STOP condition setup time | SCL SDA | 0.6 | | | 0.26 | | | μS |
| tBUF | Bus free time between STOP and START | SCL SDA | 1.3 | | | 0.5 | | | μS |

^{1.} LC898217XC is designed for a condition with typ. 20 ns of hold time. If SDA signal is unstable around falling point of SCL signal, please implement an appropriate treatment on board, such as inserting a resistor.

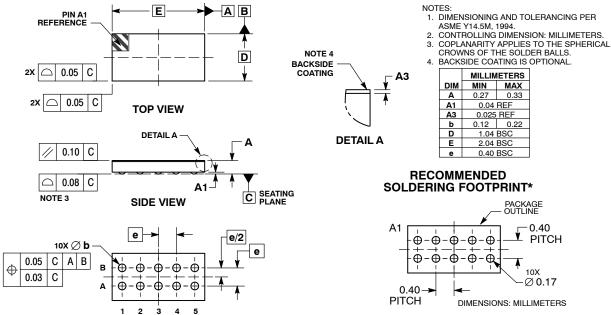






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BOTTOM VIEW

*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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